<u>onsemi.</u>

MOSFET – N-Channel, POWERTRENCH[®]

150 V, 169 A, 6.3 m Ω

FDBL0630N150

Features

- Typ $r_{DS(on)} = 5 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typ $Q_{g(tot)} = 70 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- This Device is Pb-Free and is RoHS Compliant

Applications

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch

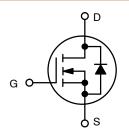
MAXIMUM RATINGS (T_J = 25°C, unless otherwise specified)

Symbol	Parameter	Ratings	Unit
VDSS	Drain to Source Voltage	150	V
VGS	Gate to Source Voltage	±20	V
Ι _D	$ Drain Current - Continuous (V_{GS} = 10 V) \\ (Note 1) T_C = 25 ^{\circ}C $	169	A
	Pulsed Drain Current $T_C = 25^{\circ}C$	See Figure 4	
EAS	Single Pulse Avalanche Energy (Note 2)	502	mJ
PD	Power Dissipation	500	W
	Derate above 25°C	3.3	W/°C
T _J , T _{STG}	Operating and Storage Temperature	-55 to +175	°C
R_{\thetaJC}	Thermal Resistance Junction to Case	0.3	°C/W
$R_{ heta JA}$	Maximum Thermal Resistance Junction to Ambient (Note 3)	43	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Current is limited by junction temperature.
- 2. Starting $T_J = 25^{\circ}C$, L = 0.24 mH, $I_{AS} = 64$ A, $V_{DD} = 100$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2 oz copper.

V _{DSS}	r _{DS(ON)} MAX	I _D MAX	
150 V	$6.3~\mathrm{m}\Omega$ @ 10 V	169 A	

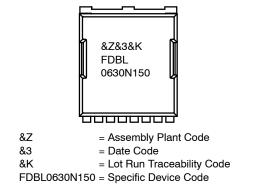


MOSFET — N-Channel



H-PSOF8L 11.68x9.80 CASE 100CU

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$		150	-	-	V
I _{DSS}	Drain to Source Leakage Current	V_{DS} = 150 V, V_{GS} = 0 V	$T_J = 25^{\circ}C$	-	-	1	μA
			T _J = 175 [°] C (Note 4)	-	-	1	mA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V		-	-	±100	nA

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, \ I_D = 250 \ \mu A$		2.0	2.8	4.0	V
r _{DS(on)}	Drain to Source On Resistance	$I_D = 80 \text{ A}, V_{GS} = 10 \text{ V}$ $T_J = 25^{\circ}\text{C}$		-	5	6.3	mΩ
			T _J = 175 [°] C (Note 4)	-	14	17.5	mΩ

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 75V, V_{GS} = 0V, f = 1 MHz	-	5805	-	pF
C _{oss}	Output Capacitance		-	536	-	pF
C _{rss}	Reverse Transfer Capacitance		-	16	-	pF
Rg	Gate Resistance	f = 1 MHz	-	2.2	-	Ω
Q _{g(ToT)}	Total Gate Charge at 10 V	V_{GS} = 0 to 10 V, V_{DD} = 75 V, I_{D} = 80 A	-	70	90	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V, V_{DD} = 75 V, I_{D} = 80 A	-	10.5	13	nC
Q _{gs}	Gate to Source Gate Charge	V _{DD} = 75 V, I _D = 80 A	-	32.5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	$V_{DD} = 75 \text{ V}, \text{ I}_{D} = 80 \text{ A}$	-	10	_	nC

SWITCHING CHARACTERISTICS

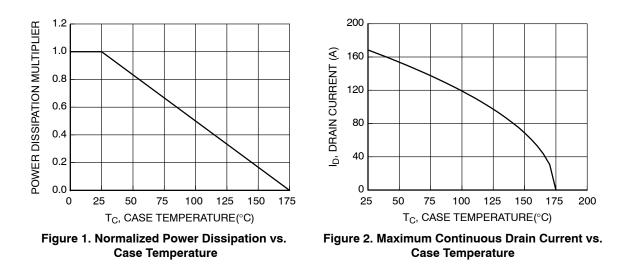
t _{on}	Turn-On Time	V_{DD} = 75 V, I_{D} = 80 A, V_{GS} = 10 V, R_{GEN} = 6 Ω	-	-	80	ns
t _{d(on)}	Turn-On Delay Time		-	39	-	ns
t _r	Rise Time		-	30	-	ns
t _{d(off)}	Turn-Off Delay Time		-	70	-	ns
t _f	Fall Time		-	23	-	ns
t _{off}	Turn-Off Time		-	-	130	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

V _{SD}	Source to Drain Diode Voltage	I _{SD} = 80 A, V _{GS} = 0 V	-	-	1.25	V
		I _{SD} = 40 A, V _{GS} = 0 V	-	-	1.2	V
T _{rr}	Reverse Recovery Time	I_F = 80 A, dI_{SD}/dt = 100 A/µs, V_DD = 120 V	-	108	125	ns
Q _{rr}	Reverse Recovery Charge		-	323	467	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS



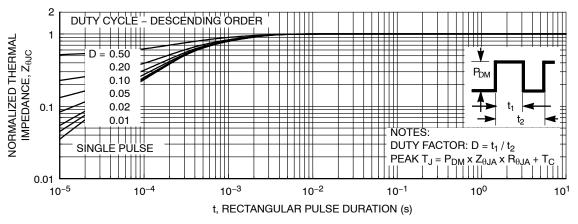


Figure 3. Normalized Maximum Transient Thermal Impedance

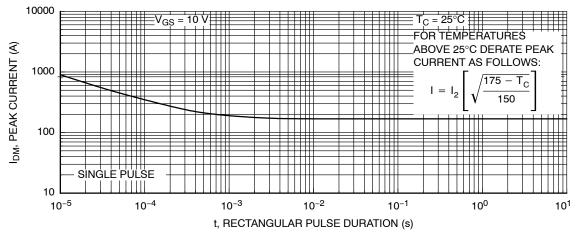
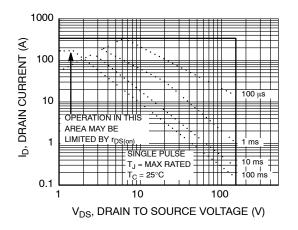


Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (continued)



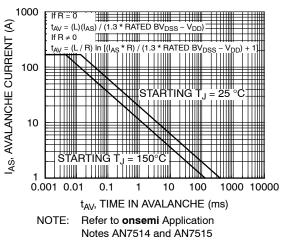


Figure 6. Unclamped Inductive Switching Capability

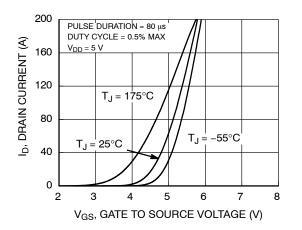


Figure 5. Forward Bias Safe Operating Area

Figure 7. Transfer Characteristics

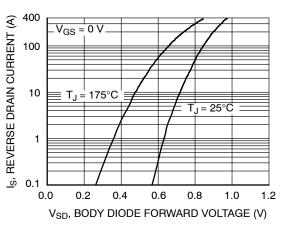
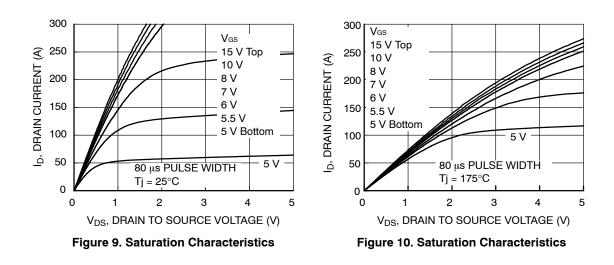
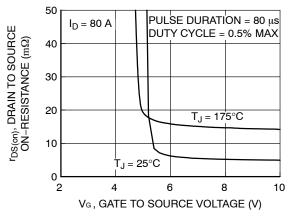


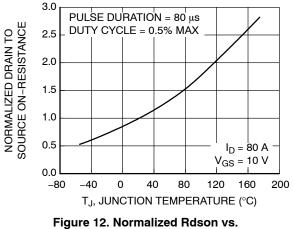
Figure 8. Forward Diode Characteristics



TYPICAL CHARACTERISTICS (continued)







Junction Temperature

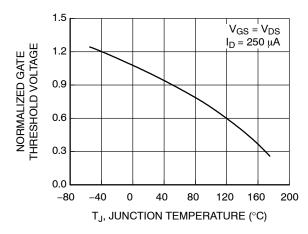


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

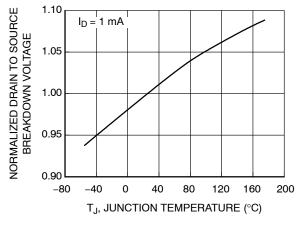


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

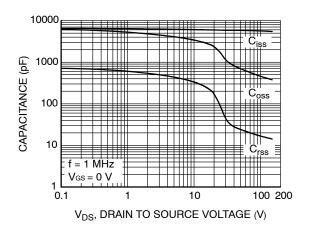


Figure 15. Capacitance vs Drain to Source Voltage

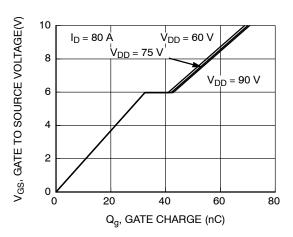


Figure 16. Gate Charge vs Gate to Source Voltage

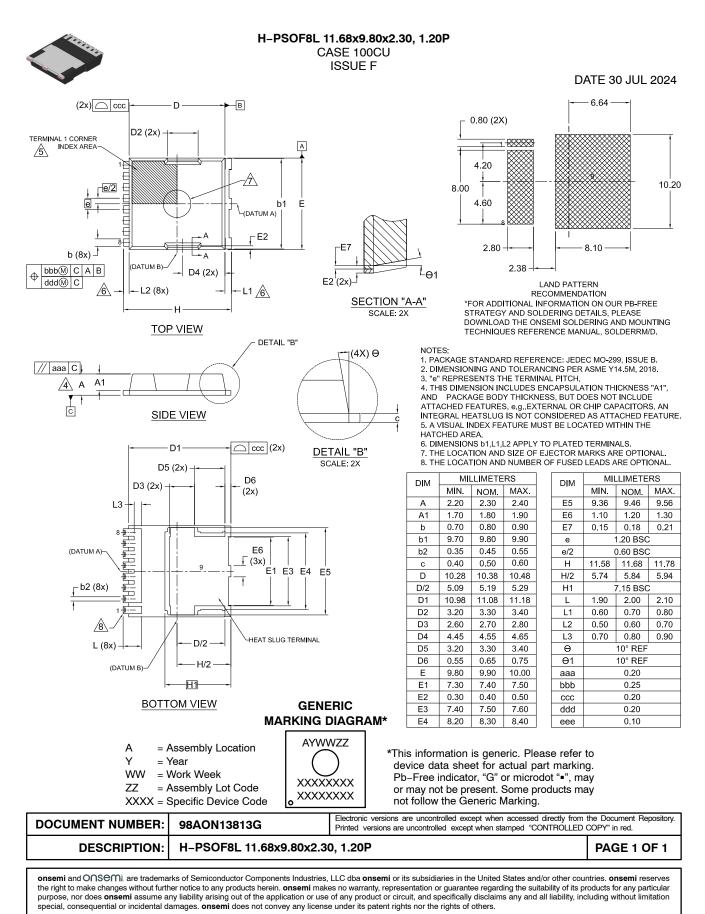
ORDERING INFORMATION

Device	Device Marking	Package	Shipping [†]
FDBL0630N150	FDBL0630N150	H–PSOF8L 11.68x9.80 (Pb–Free)	2000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

POWERTRENCH is registered trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

onsemi



onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>